

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE2030 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

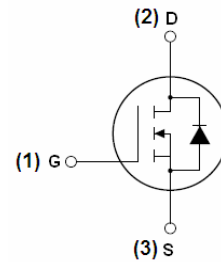
- $V_{DS} = 20V, I_D = 30A$
- $R_{DS(ON)} < 12m\Omega @ V_{GS} = 10V$ (Typ: 10.5m Ω)
- $R_{DS(ON)} < 13m\Omega @ V_{GS} = 4.5V$ (Typ: 11m Ω)
- $R_{DS(ON)} < 18m\Omega @ V_{GS} = 2.5V$ (Typ: 14m Ω)
- High density cell design for ultra low R_{dson}
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Load switching
- Uninterruptible power supply

100% UIS TESTED!

100% ΔV_{ds} TESTED!



Schematic diagram



Marking and pin assignment



TO-220-3L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE2030	NCE2030	TO-220-3L	-	-	-

Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Drain Current-Continuous	I_D	30	A
Drain Current-Continuous($T_C = 100^\circ C$)	$I_D(100^\circ C)$	21	A
Pulsed Drain Current	I_{DM}	100	A
Maximum Power Dissipation	P_D	40	W
Single pulse avalanche energy ^(Note 5)	E_{AS}	150	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	$^\circ C$

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{\theta JC}$	3.8	$^\circ C/W$
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Electrical Characteristics (T_A=25°C unless otherwise noted)

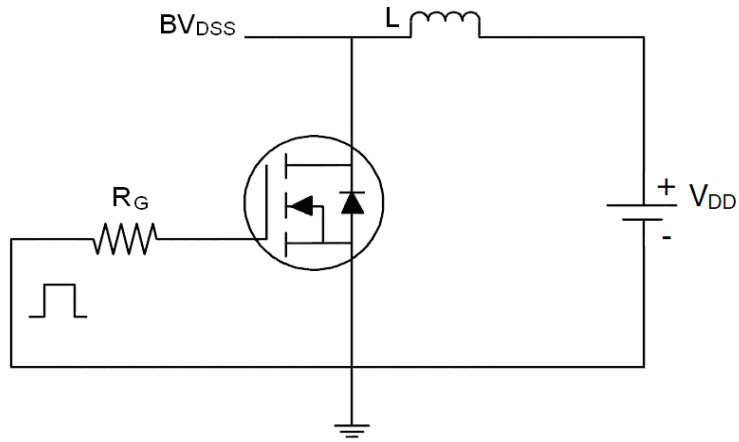
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V, V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.5	0.7	1.2	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	-	10.5	12	mΩ
		V _{GS} =4.5V, I _D =20A	-	11	13	mΩ
		V _{GS} =2.5V, I _D =20A	-	14	18	mΩ
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =20A	10	-	-	S
Dynamic Characteristics (Note 4)						
Input Capacitance	C _{iss}	V _{DS} =10V, V _{GS} =0V, F=1.0MHz		1544		PF
Output Capacitance	C _{oss}			210.1		PF
Reverse Transfer Capacitance	C _{rss}			201.4		PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}	V _{GS} =10V, V _{DS} =10V R _L =0.5Ω, R _{GEN} =3Ω	-	4.5	-	nS
Turn-on Rise Time	t _r		-	9.2	-	nS
Turn-Off Delay Time	t _{d(off)}		-	18.7	-	nS
Turn-Off Fall Time	t _f		-	3.3	-	nS
Total Gate Charge	Q _g	V _{GS} =4.5V, V _{DS} =10V, I _D =20A		23.5		nC
Gate-Source Charge	Q _{gs}			2.8		nC
Gate-Drain Charge	Q _{gd}			5.75		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V, I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	I _S	-	-	-	30	A
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 20A di/dt = 100A/μs (Note 3)	-	18	-	nS
Reverse Recovery Charge	Q _{rr}		-	9.5	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition: T_J=25°C, V_{DD}=10V, V_G=10V, L=0.5mH, R_g=25Ω

Test circuit

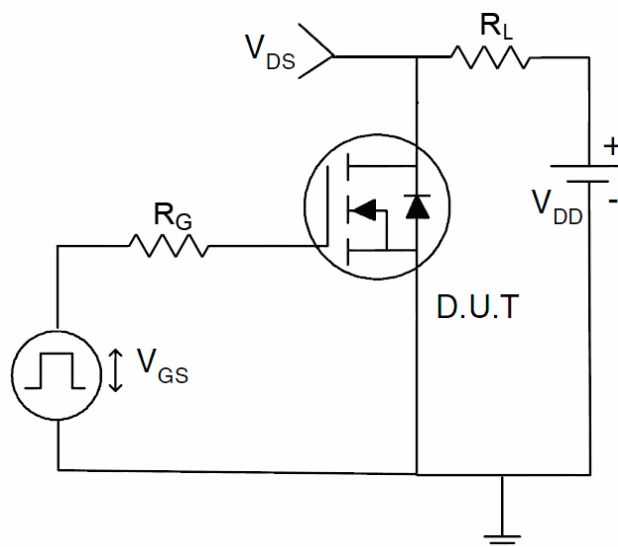
1) E_{AS} test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:



Typical Electrical and Thermal Characteristics (Curves)

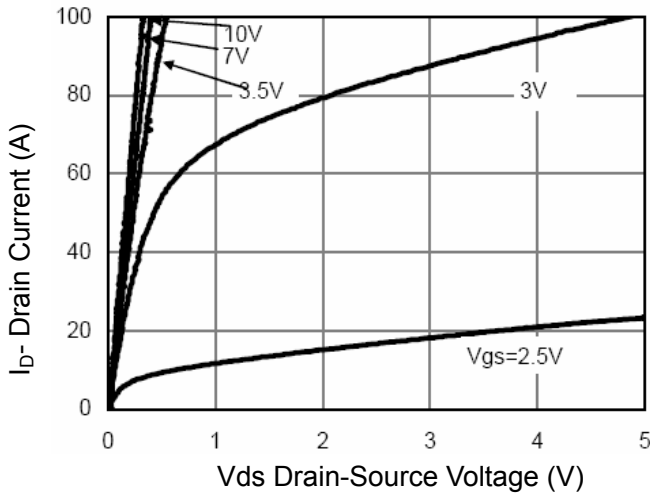


Figure 1 Output Characteristics

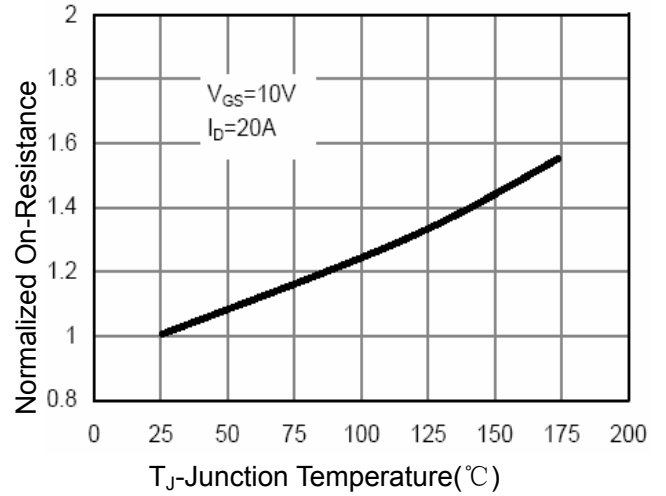


Figure 4 Rdson-Junction Temperature

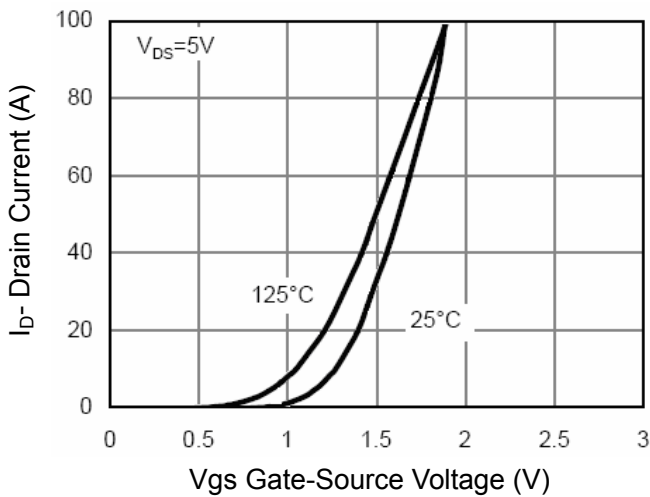


Figure 2 Transfer Characteristics

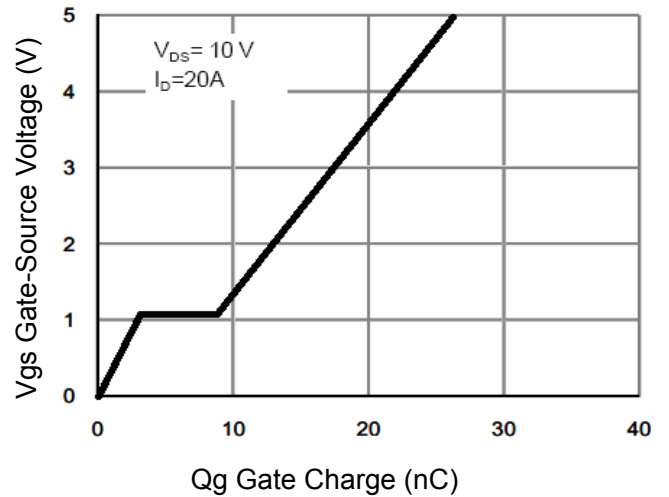


Figure 5 Gate Charge

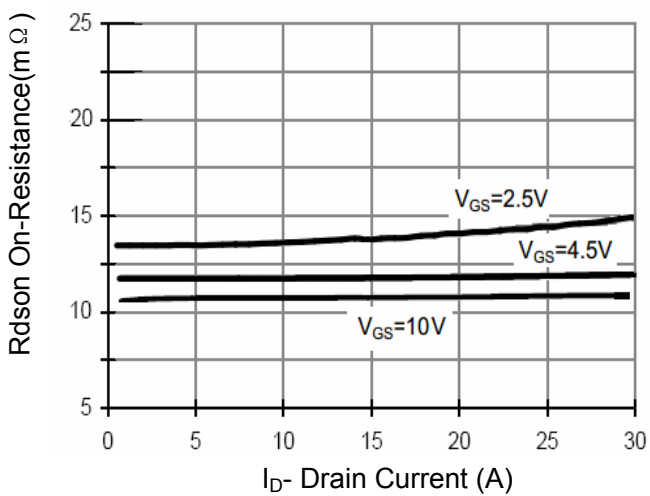


Figure 3 Rdson- Drain Current

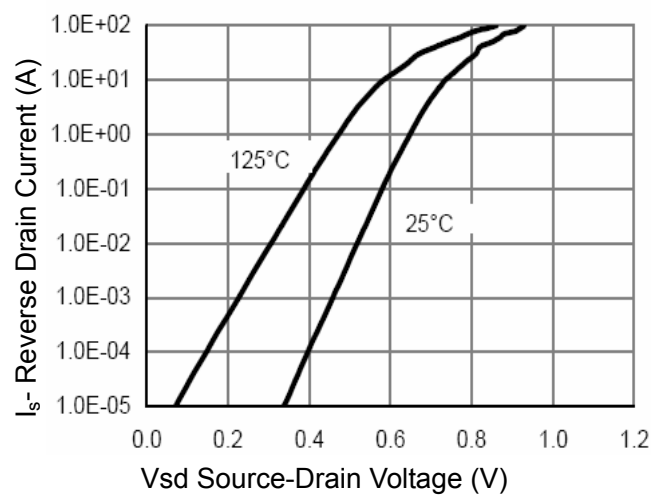


Figure 6 Source- Drain Diode Forward

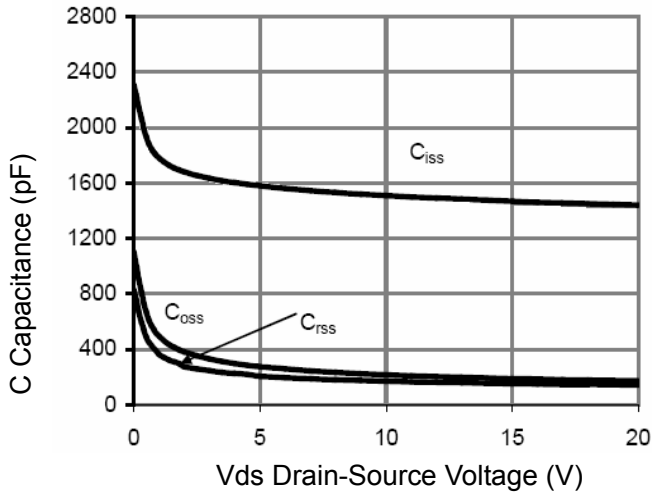


Figure 7 Capacitance vs Vds

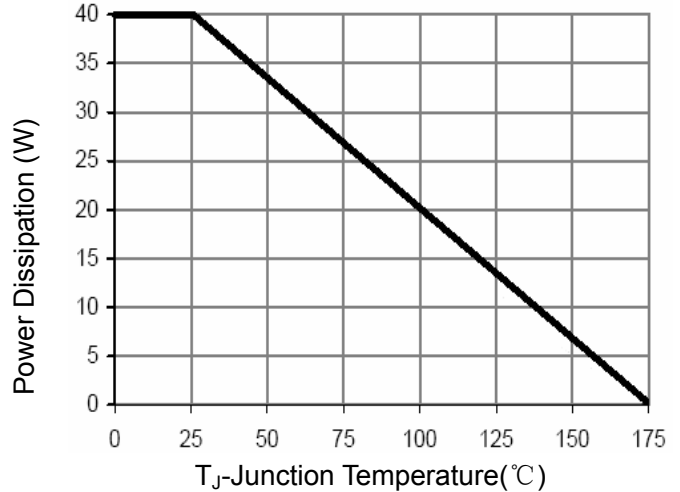


Figure 9 Power De-rating

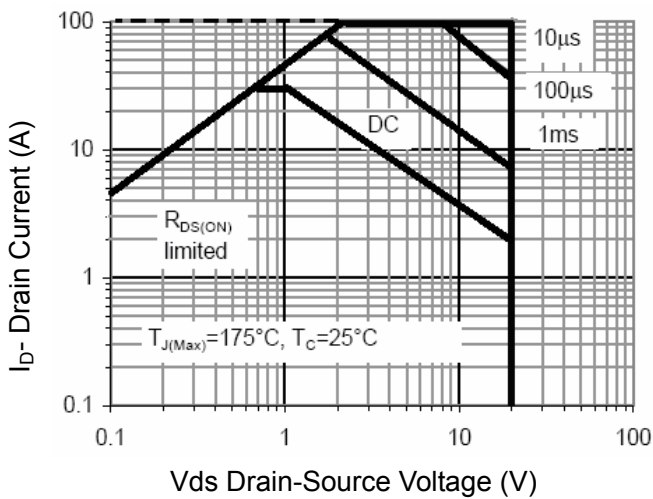


Figure 8 Safe Operation Area

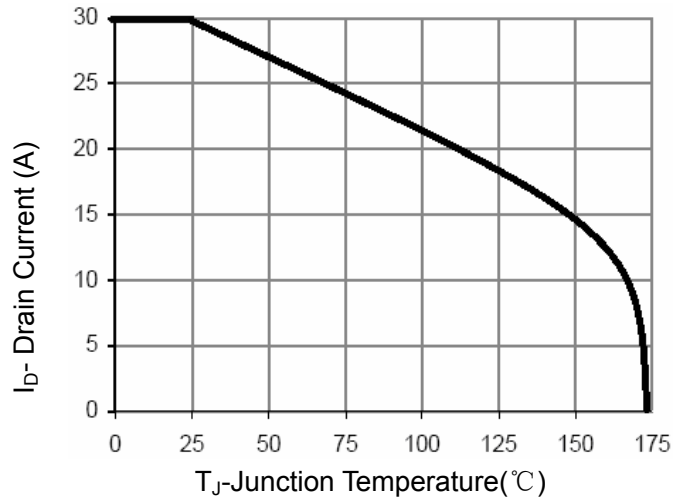


Figure 10 Current De-rating

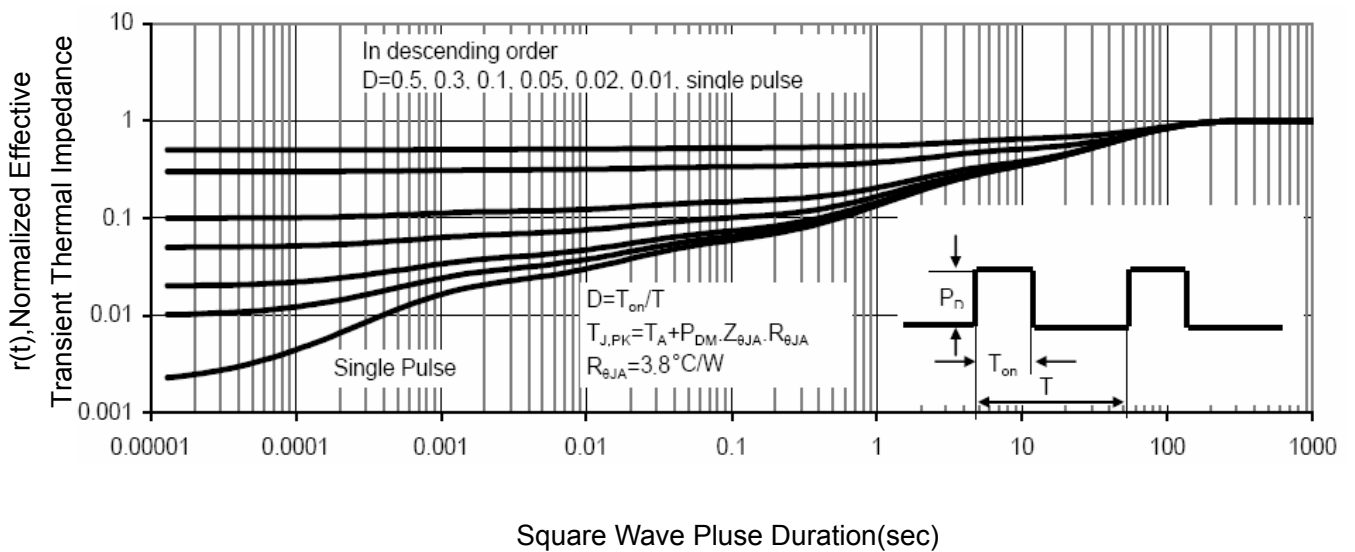
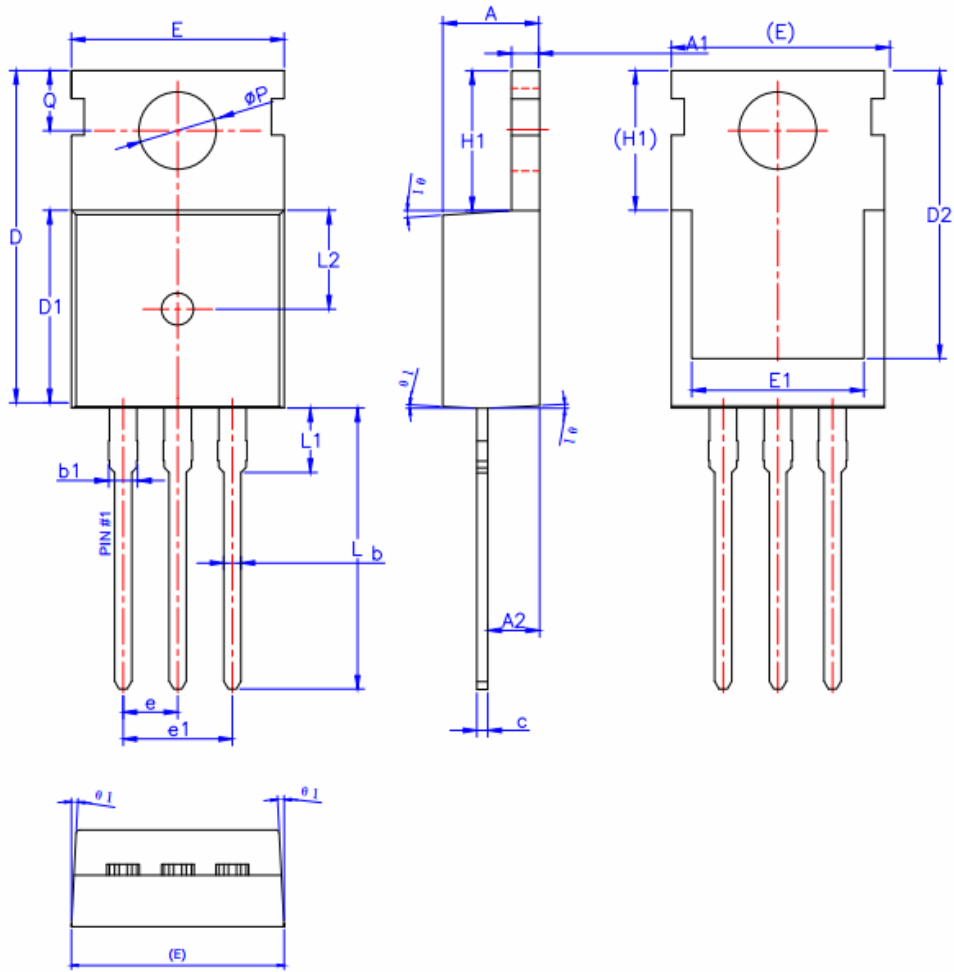


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-220-3L Package Information



SYMBOL	MIN	NOM	MAX
A	4.40	4.50	4.60
A1	1.27	1.30	1.33
A2	2.30	2.40	2.50
b	0.70	-	0.90
b1	-	-	1.40
c	0.45	0.50	0.60
D	15.30	15.70	16.10
D1	9.10	9.20	9.30
D2	13.10	-	13.70
E	9.70	9.90	10.20
E1	7.80	8.00	8.20
e	2.54BSC		
e1	5.08BSC		
H1	6.30	6.50	6.70
L	12.78	13.08	13.38
L1	-	-	3.50
L2	4.60REF		
øP	3.55	3.60	3.65
Q	2.73	-	2.87
θ1	1°	3°	5°

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